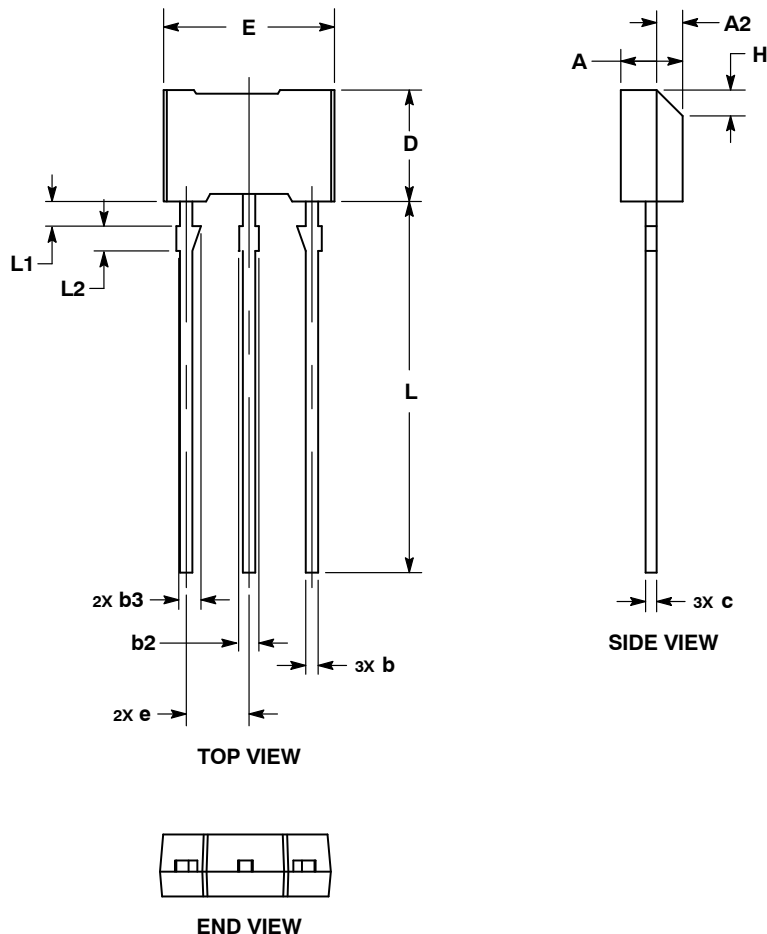




**NMP (Taping)**  
**CASE 135AD**  
**ISSUE B**

DATE 14 JUL 2015



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.
4. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

DIM	MILLIMETERS	
	MIN	MAX
A	2.30	2.70
A2	0.85	1.25
b	0.40	0.60
b2	0.50	0.70
b3	0.75	1.05
c	0.35	0.55
D	4.30	4.70
E	6.70	7.10
e	2.44	2.64
H	0.80	1.20
L	14.50	15.50
L1	0.80	1.20
L2	0.80	1.20

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